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What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Obsolete
Core Processor	8051
Core Size	8-Bit
Speed	18MHz
Connectivity	I²C, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	14
Program Memory Size	2KB (2K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	256 x 8
Voltage - Supply (Vcc/Vdd)	2.4V ~ 3.6V
Data Converters	A/D 4x8b; D/A 1x8b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	16-TSSOP (0.173", 4.40mm Width)
Supplier Device Package	16-TSSOP
Purchase URL	https://www.e-xfl.com/product-detail/nxp-semiconductors/p89lpc9161fdh-129

3. Ordering information

Table 1. Ordering information

Type number	Package		
	Name	Description	Version
P89LPC9151FDH	TSSOP14	plastic thin shrink small outline package; 14 leads; body width 4.4 mm	SOT402-1
P89LPC9161FDH	TSSOP16	plastic thin shrink small outline package; 16 leads; body width 4.4 mm	SOT403-1
P89LPC9171FDH	TSSOP16	plastic thin shrink small outline package; 16 leads; body width 4.4 mm	SOT403-1

3.1 Ordering options

Table 2. Ordering options

Type number	Flash memory	Temperature range	Frequency
P89LPC9151FDH	2 kB	−40 °C to +85 °C	0 MHz to 18 MHz
P89LPC9161FDH	2 kB	−40 °C to +85 °C	0 MHz to 18 MHz
P89LPC9171FDH	2 kB	−40 °C to +85 °C	0 MHz to 18 MHz

Table 3. P89LPC9151 Pin description

Symbol	Pin	Type	Description
	TSSOP14		
P1.0/TXD	9	I/O	**P1.0 —** Port 1 bit 0.
		O	**TXD —** Transmitter output for serial port.
P1.1/RXD	8	I/O	**P1.1 —** Port 1 bit 1.
		I	**RXD —** Receiver input for serial port.
P1.2/T0/SCL	7	I/O	**P1.2 —** Port 1 bit 2 (open-drain when used as output).
		I/O	**T0 —** Timer/counter 0 external count input or overflow output (open-drain when used as output).
		I/O	**SCL —** I^2C-bus serial clock input/output.
P1.3/$\overline{\text{INT0}}$/SDA	6	I/O	**P1.3 —** Port 1 bit 3 (open-drain when used as output).
		I	**$\overline{\text{INT0}}$ —** External interrupt 0 input.
		I/O	**SDA —** I^2C-bus serial data input/output.
P1.4/$\overline{\text{INT1}}$	5	I/O	**P1.4 —** Port 1 bit 4. High current source.
		I	**$\overline{\text{INT1}}$ —** External interrupt 1 input.
P1.5/$\overline{\text{RST}}$	3	I	**P1.5 —** Port 1 bit 5 (input only).
		I	**$\overline{\text{RST}}$ —** External Reset input during power-on or if selected via UCFG1. When functioning as a reset input, a LOW on this pin resets the microcontroller, causing I/O ports and peripherals to take on their default states, and the processor begins execution at address 0. Also used during a power-on sequence to force ISP mode.
V_{SS}	4	I	**Ground:** 0 V reference.
V_{DD}	10	I	**Power supply:** This is the power supply voltage for normal operation as well as Idle and Power-down modes.

[1] Input/output for P1.0 to P1.4. Input for P1.5.

Table 4. P89LPC9161 Pin description

Symbol	Pin	Type	Description
	TSSOP16		
P0.1 to P0.5		I/O	**Port 0:** Port 0 is an 5-bit I/O port with a user-configurable output type. During reset Port 0 latches are configured in the input only mode with the internal pull-up disabled. The operation of Port 0 pins as inputs and outputs depends upon the port configuration selected. Each port pin is configured independently. Refer to Section 7.15.1 “Port configurations” and Table 16 “Static characteristics” for details. The Keypad Interrupt feature operates with Port 0 pins. All pins have Schmitt trigger inputs. Port 0 also provides various special functions as described below:
P0.1/CIN2B/ KBI1/AD10	1	I/O	**P0.1 —** Port 0 bit 1.
		I	**CIN2B —** Comparator 2 positive input B.
		I	**KBI1 —** Keyboard input 1.
		I	**AD10 —** ADC1 channel 0 analog input.
P0.2/CIN2A/ KBI2/AD11	16	I/O	**P0.2 —** Port 0 bit 2.
		I	**CIN2A —** Comparator 2 positive input A.
		I	**KBI2 —** Keyboard input 2.
		I	**AD11 —** ADC1 channel 1 analog input.
P0.3/CIN1B/ KBI3/AD12	15	I/O	**P0.3 —** Port 0 bit 3. High current source.
		I	**CIN1B —** Comparator 1 positive input B.
		I	**KBI3 —** Keyboard input 3.
		I	**AD12 —** ADC1 channel 2 analog input.
P0.4/CIN1A/ KBI4/DAC1/AD13	14	I/O	**P0.4 —** Port 0 bit 4. High current source.
		I	**CIN1A —** Comparator 1 positive input A.
		I	**KBI4 —** Keyboard input 4.
		O	**DAC1 —** Digital-to-analog converter output 1.
		I	**AD13 —** ADC1 channel 3 analog input.
P0.5/CMPREF/ KBI5	13	I/O	**P0.5 —** Port 0 bit 5. High current source.
		I	**CMPREF —** Comparator reference (negative) input.
		I	**KBI5 —** Keyboard input 5.
		I	**CLKIN —** External clock input.
P1.0 to P1.3, P1.5		I/O, I [1]	**Port 1:** Port 1 is an 5-bit I/O port with a user-configurable output type, except for three pins as noted below. During reset Port 1 latches are configured in the input only mode with the internal pull-up disabled. The operation of the configurable Port 1 pins as inputs and outputs depends upon the port configuration selected. Each of the configurable port pins are programmed independently. Refer to Section 7.15.1 “Port configurations” and Table 16 “Static characteristics” for details. P1.2 to P1.3 are open drain when used as outputs. P1.5 is input only. All pins have Schmitt trigger inputs. Port 1 also provides various special functions as described below:
P1.0/TXD	10	I/O	**P1.0 —** Port 1 bit 0.
		O	**TXD —** Transmitter output for serial port.
P1.1/RXD	9	I/O	**P1.1 —** Port 1 bit 1.
		I	**RXD —** Receiver input for serial port.

Table 4. P89LPC9161 Pin description

Symbol	Pin	Type	Description
	TSSOP16		
P1.2/T0/SCL	8	I/O	**P1.2 —** Port 1 bit 2 (open-drain when used as output).
		I/O	**T0 —** Timer/counter 0 external count input or overflow output (open-drain when used as output).
		I/O	**SCL —** I^2C-bus serial clock input/output.
P1.3/$\overline{INT0}$/SDA	7	I/O	**P1.3 —** Port 1 bit 3 (open-drain when used as output).
		I	**$\overline{INT0}$ —** External interrupt 0 input.
		I/O	**SDA —** I^2C-bus serial data input/output.
P1.5/$\overline{RST}$	3	I	**P1.5 —** Port 1 bit 5 (input only).
		I	**$\overline{RST}$ —** External Reset input during power-on or if selected via UCFG1. When functioning as a reset input, a LOW on this pin resets the microcontroller, causing I/O ports and peripherals to take on their default states, and the processor begins execution at address 0. Also used during a power-on sequence to force ISP mode.
P2.2 to P2.5		I/O	**Port 2:** Port 2 is an 4-bit I/O port with a user-configurable output type. During reset Port 2 latches are configured in the input only mode with the internal pull-up disabled. The operation of Port 2 pins as inputs and outputs depends upon the port configuration selected. Each port pin is configured independently. Refer to Section 7.15 “I/O ports” for details. All pins have Schmitt trigger inputs. Port 2 also provides various special functions as described below:
P2.2/MOSI	6	I/O	**P2.2 —** Port 2 bit 2.
		I/O	**MOSI —** SPI master out slave in. When configured as master, this pin is output; when configured as slave, this pin is input.
P2.3/MISO	5	I/O	**P2.3 —** Port 2 bit 3.
		I/O	**MISO —** When configured as master, this pin is input, when configured as slave, this pin is output.
P2.4/$\overline{SS}$	2	I/O	**P2.4 —** Port 2 bit 4.
		I	**$\overline{SS}$ —** SPI Slave select.
P2.5/SPICLK	11	I/O	**P2.5 —** Port 2 bit 5.
		I/O	**SPICLK —** SPI clock. When configured as master, this pin is output; when configured as slave, this pin is input.
V_{SS}	4	I	**Ground:** 0 V reference.
V_{DD}	12	I	**Power supply:** This is the power supply voltage for normal operation as well as Idle and Power-down modes.

[1] Input/output for P1.0 to P1.3. Input for P1.5.

Table 5. P89LPC9171 Pin description

Symbol	Pin	Type	Description
	TSSOP16		
P1.0 to P1.5		I/O, I [1]	**Port 1:** Port 1 is an 6-bit I/O port with a user-configurable output type, except for three pins as noted below. During reset Port 1 latches are configured in the input only mode with the internal pull-up disabled. The operation of the configurable Port 1 pins as inputs and outputs depends upon the port configuration selected. Each of the configurable port pins are programmed independently. Refer to Section 7.15.1 “Port configurations” and Table 16 “Static characteristics” for details. P1.2 to P1.3 are open drain when used as outputs. P1.5 is input only. All pins have Schmitt trigger inputs. Port 1 also provides various special functions as described below:
P1.0/TXD	10	I/O	**P1.0 —** Port 1 bit 0.
		O	**TXD —** Transmitter output for serial port.
P1.1/RXD	9	I/O	**P1.1 —** Port 1 bit 1.
		I	**RXD —** Receiver input for serial port.
P1.2/T0/SCL	8	I/O	**P1.2 —** Port 1 bit 2 (open-drain when used as output).
		I/O	**T0 —** Timer/counter 0 external count input or overflow output (open-drain when used as output).
		I/O	**SCL —** I^2C-bus serial clock input/output.
P1.3/$\overline{\text{INT0}}$/SDA	7	I/O	**P1.3 —** Port 1 bit 3 (open-drain when used as output).
		I	**$\overline{\text{INT0}}$ —** External interrupt 0 input.
		I/O	**SDA —** I^2C-bus serial data input/output.
P1.4/$\overline{\text{INT1}}$	6	I/O	**P1.4 —** Port 1 bit 4. High current source.
		I	**$\overline{\text{INT1}}$ —** External interrupt 1 input.
P1.5/$\overline{\text{RST}}$	3	I	**P1.5 —** Port 1 bit 5 (input only).
		I	**$\overline{\text{RST}}$ —** External Reset input during power-on or if selected via UCFG1. When functioning as a reset input, a LOW on this pin resets the microcontroller, causing I/O ports and peripherals to take on their default states, and the processor begins execution at address 0. Also used during a power-on sequence to force ISP mode.
P2.2	5	I/O	**Port 2:** P2.2 is a single-bit I/O port with a user-configurable output type. During reset P2.2 latch is configured in the input only mode with the internal pull-up disabled. The operation of the output depends upon the port configuration selected. Refer to Section 7.15 “I/O ports” for details. This pin has Schmitt trigger inputs.
V_{SS}	4	I	**Ground:** 0 V reference.
V_{DD}	12	I	**Power supply:** This is the power supply voltage for normal operation as well as Idle and Power-down modes.

[1] Input/output for P1.0 to P1.4. Input for P1.5.

Table 6. Special function registers - P89LPC9151

** indicates SFRs that are bit addressable.*

Name	Description	SFR addr.	Bit functions and addresses								Reset value	
			MSB							LSB	Hex	Binary
RTCH	RTC register high	D2H									00[6]	0000 0000
RTCL	RTC register low	D3H									00[6]	0000 0000
SADDR	Serial port address register	A9H									00	0000 0000
SADEN	Serial port address enable	B9H									00	0000 0000
SBUF	Serial Port data buffer register	99H									xx	xxxx xxxx
	Bit address		**9F**	**9E**	**9D**	**9C**	**9B**	**9A**	**99**	**98**		
SCON*	Serial port control	98H	SM0/FE	SM1	SM2	REN	TB8	RB8	TI	RI	00	0000 0000
SSTAT	Serial port extended status register	BAH	DBMOD	INTLO	CIDIS	DBISEL	FE	BR	OE	STINT	00	0000 0000
SP	Stack pointer	81H									07	0000 0111
TAMOD	Timer 0 and 1 auxiliary mode	8FH	-	-	-	-	-	-	-	T0M2	00	xxx0 xxx0
	Bit address		**8F**	**8E**	**8D**	**8C**	**8B**	**8A**	**89**	**88**		
TCON*	Timer 0 and 1 control	88H	TF1	TR1	TF0	TR0	IE1	IT1	IE0	IT0	00	0000 0000
TH0	Timer 0 high	8CH									00	0000 0000
TH1	Timer 1 high	8DH									00	0000 0000
TL0	Timer 0 low	8AH									00	0000 0000
TL1	Timer 1 low	8BH									00	0000 0000
TMOD	Timer 0 and 1 mode	89H	T1GATE	T1C/$\overline{T}$	T1M1	T1M0	T0GATE	T0C/$\overline{T}$	T0M1	T0M0	00	0000 0000
TRIM	Internal oscillator trim register	96H	RCCLK	-	TRIM.5	TRIM.4	TRIM.3	TRIM.2	TRIM.1	TRIM.0	[5][6]	

Table 6. Special function registers - P89LPC9151

** indicates SFRs that are bit addressable.*

Name	Description	SFR addr.	Bit functions and addresses								Reset value	
			MSB							LSB	Hex	Binary
WDCON	Watchdog control register	A7H	PRE2	PRE1	PRE0	-	-	WDRUN	WDTOF	WDCLK	[4][6]	
WDL	Watchdog load	C1H									FF	1111 1111
WFEED1	Watchdog feed 1	C2H										
WFEED2	Watchdog feed 2	C3H										

[1] All ports are in input only (high-impedance) state after power-up.

[2] BRGR1 and BRGR0 must only be written if BRGEN in BRGCON SFR is logic 0. If any are written while BRGEN = 1, the result is unpredictable.

[3] The RSTSRC register reflects the cause of the P89LPC9151 reset except BOIF bit. Upon a power-up reset, all reset source flags are cleared except POF and BOF; the power-on reset value is x011 0000.

[4] After reset, the value is 1110 01x1, i.e., PRE2 to PRE0 are all logic 1, WDRUN = 1 and WDCLK = 1. WDTOF bit is logic 1 after watchdog reset and is logic 0 after power-on reset. Other resets will not affect WDTOF.

[5] On power-on reset and watchdog reset, the TRIM SFR is initialized with a factory preprogrammed value. Other resets will not cause initialization of the TRIM register.

[6] The only reset sources that affect these SFRs are power-on reset and watchdog reset.

Table 8. Special function registers - P89LPC9161

** indicates SFRs that are bit addressable.*

Name	Description	SFR addr.	Bit functions and addresses								Reset value	
			MSB							LSB	Hex	Binary
	Bit address		**DF**	**DE**	**DD**	**DC**	**DB**	**DA**	**D9**	**D8**		
I2CON*	I^2C-bus control register	D8H	-	I2EN	STA	STO	SI	AA	-	CRSEL	00	x000 00x0
I2DAT	I^2C-bus data register	DAH										
I2SCLH	Serial clock generator/SCL duty cycle register high	DDH									00	0000 0000
I2SCLL	Serial clock generator/SCL duty cycle register low	DCH									00	0000 0000
I2STAT	I^2C-bus status register	D9H	STA.4	STA.3	STA.2	STA.1	STA.0	0	0	0	F8	1111 1000
	Bit address		**AF**	**AE**	**AD**	**AC**	**AB**	**AA**	**A9**	**A8**		
IEN0*	Interrupt enable 0	A8H	EA	EWDRT	EBO	ES/ESR	ET1	-	ET0	EX0	00	0000 0000
	Bit address		**EF**	**EE**	**ED**	**EC**	**EB**	**EA**	**E9**	**E8**		
IEN1*	Interrupt enable 1	E8H	EAD	EST	-	-	ESPI	EC	EKBI	EI2C	00[1]	00x0 0000
	Bit address		**BF**	**BE**	**BD**	**BC**	**BB**	**BA**	**B9**	**B8**		
IP0*	Interrupt priority 0	B8H	-	PWDRT	PBO	PS/PSR	PT1	-	PT0	PX0	00[1]	x000 0000
IP0H	Interrupt priority 0 high	B7H	-	PWDRTH	PBOH	PSH/ PSRH	PT1H	-	PT0H	PX0H	00[1]	x000 0000
	Bit address		**FF**	**FE**	**FD**	**FC**	**FB**	**FA**	**F9**	**F8**		
IP1*	Interrupt priority 1	F8H	PAD	PST	-	-	PSPI	PC	PKBI	PI2C	00[1]	00x0 0000
IP1H	Interrupt priority 1 high	F7H	PADH	PSTH	-	-	PSPIH	PCH	PKBIH	PI2CH	00[1]	00x0 0000
KBCON	Keypad control register	94H	-	-	-	-	-	-	PATN _SEL	KBIF	00[1]	xxxx xx00

Table 11. Extended special function registers - P89LPC9171[1]

Name	Description	SFR addr.	Bit functions and addresses								Reset value	
			MSB							LSB	Hex	Binary
BODCFG	BOD configuration register	FFC8H	-	-	-	-	-	-	BOICFG1	BOICFG0	[2]	
CLKCON	CLOCK Control register	FFDEH	CLKOK	-	-	-	CLKDBL	FOSC2	FOSC1	FOSC0	[3]	
RTCDATH	Real-time clock data register high	FFBFH									00	0000 0000
RTCDATL	Real-time clock data register low	FFBEH									00	0000 0000

[1] Extended SFRs are physically located on-chip but logically located in external data memory address space (XDATA). The MOVX A,@DPTR and MOVX @DPTR,A instructions are used to access these extended SFRs.

[2] The BOICFG1/0 will be copied from UCFG1.5 and UCFG1.3 when power-on reset.

[3] CLKCON register reset value comes from UCFG1 and UCFG2. The reset value of CLKCON.2 to CLKCON.0 come from UCFG1.2 to UCFG1.0 and reset value of CLKDBL bit comes from UCFG2.7.

LOW, it is driven strongly and able to sink a fairly large current. These features are somewhat similar to an open-drain output except that there are three pull-up transistors in the quasi-bidirectional output that serve different purposes.

The P89LPC9151/9161/9171 is a 3 V device, but the pins are 5 V tolerant. In quasi-bidirectional mode, if a user applies 5 V on the pin, there will be a current flowing from the pin to V_{DD}, causing extra power consumption. Therefore, applying 5 V in quasi-bidirectional mode is discouraged.

A quasi-bidirectional port pin has a Schmitt trigger input that also has a glitch suppression circuit.

7.15.1.2 Open-drain output configuration

The open-drain output configuration turns off all pull-ups and only drives the pull-down transistor of the port driver when the port latch contains a logic 0. To be used as a logic output, a port configured in this manner must have an external pull-up, typically a resistor tied to V_{DD}.

An open-drain port pin has a Schmitt trigger input that also has a glitch suppression circuit.

7.15.1.3 Input-only configuration

The input-only port configuration has no output drivers. It is a Schmitt trigger input that also has a glitch suppression circuit.

7.15.1.4 Push-pull output configuration

The push-pull output configuration has the same pull-down structure as both the open-drain and the quasi-bidirectional output modes, but provides a continuous strong pull-up when the port latch contains a logic 1. The push-pull mode may be used when more source current is needed from a port output. A push-pull port pin has a Schmitt triggered input that also has a glitch suppression circuit. The P89LPC9151/9161/9171 device has high current source on eight pins in push-pull mode. See Table 15 “Limiting values”.

7.15.2 Port 0 analog functions

The P89LPC9151/9161/9171 incorporates two Analog Comparators. In order to give the best analog function performance and to minimize power consumption, pins that are being used for analog functions must have the digital outputs and digital inputs disabled.

Digital outputs are disabled by putting the port output into the Input-Only (high-impedance) mode.

Digital inputs on Port 0 may be disabled through the use of the PT0AD register, bits 1:5. On any reset, PT0AD[1:5] defaults to logic 0s to enable digital functions.

7.15.3 Additional port features

After power-up, all pins are in Input-Only mode. **Please note that this is different from the LPC76x series of devices.**

- After power-up, all I/O pins except P1.5, may be configured by software.
- Pin P1.5 is input only. Pins P1.2 and P1.3 are configurable for either input-only or open-drain.

7.19.6 Timer overflow toggle output

Timer 0 (and Timer 1 on the P89LPC9171) can be configured to automatically toggle a port output whenever a timer overflow occurs. The same device pins that are used for the T0 and T1 count inputs are also used for the timer toggle outputs. The port outputs will be a logic 1 prior to the first timer overflow when this mode is turned on.

7.20 RTC/system timer

The P89LPC9151/9161/9171 has a simple RTC that allows a user to continue running an accurate timer while the rest of the device is powered down. The RTC can be a wake-up or an interrupt source. The RTC is a 23-bit down counter comprised of a 7-bit prescaler and a 16-bit loadable down counter. When it reaches all logic 0s, the counter will be reloaded again and the RTCF flag will be set.

The clock source for this counter can be either the CPU clock (CCLK) or the external clock input, provided that the external clock input is not being used as the CPU clock. If the external clock input is used as the CPU clock, then the RTC will use CCLK as its clock source. Only power-on reset will reset the RTC and its associated SFRs to the default state.

The 16-bit loadable counter portion of the RTC is readable by reading the RTCDATL and RTCDATH registers.

7.21 UART

The P89LPC9151/9161/9171 has an enhanced UART that is compatible with the conventional 80C51 UART except that Timer 2 overflow cannot be used as a baud rate source. The P89LPC9151/9161/9171 does include an independent baud rate generator. The baud rate can be selected from the oscillator (divided by a constant), Timer 1 overflow, or the independent baud rate generator. In addition to the baud rate generation, enhancements over the standard 80C51 UART include Framing Error detection, automatic address recognition, selectable double buffering and several interrupt options. The UART can be operated in four modes: shift register, 8-bit UART, 9-bit UART, and CPU clock/32 or CPU clock/16.

7.21.1 Mode 0

Serial data enters and exits through RXD. TXD outputs the shift clock. 8 bits are transmitted or received, LSB first. The baud rate is fixed at $^{1}/_{16}$ of the CPU clock frequency.

7.21.2 Mode 1

10 bits are transmitted (through TXD) or received (through RXD): a start bit (logic 0), 8 data bits (LSB first), and a stop bit (logic 1). When data is received, the stop bit is stored in RB8 in special function register SCON. The baud rate is variable and is determined by the Timer 1 overflow rate or the baud rate generator (described in Section 7.21.5 “Baud rate generator and selection”).

7.21.3 Mode 2

11 bits are transmitted (through TXD) or received (through RXD): start bit (logic 0), 8 data bits (LSB first), a programmable 9th data bit, and a stop bit (logic 1). When data is transmitted, the 9th data bit (TB8 in SCON) can be assigned the value of logic 0 or logic 1.

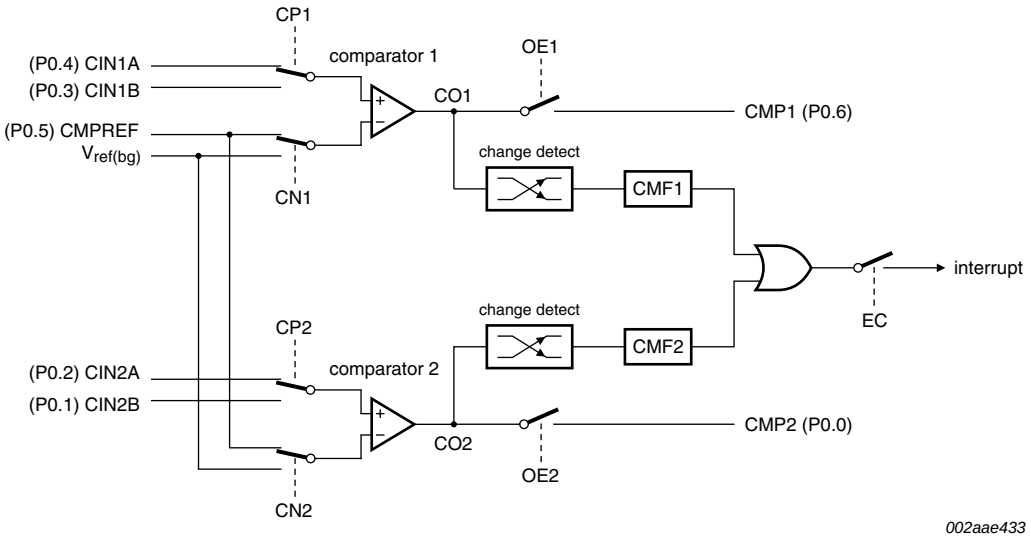


Fig 19. Comparator input and output connections

7.24.1 Internal reference voltage

An internal reference voltage generator may supply a default reference when a single comparator input pin is used. The value of the internal reference voltage, referred to as $V_{ref(bg)}$, is 1.23 V ± 10 %.

7.24.2 Comparator interrupt

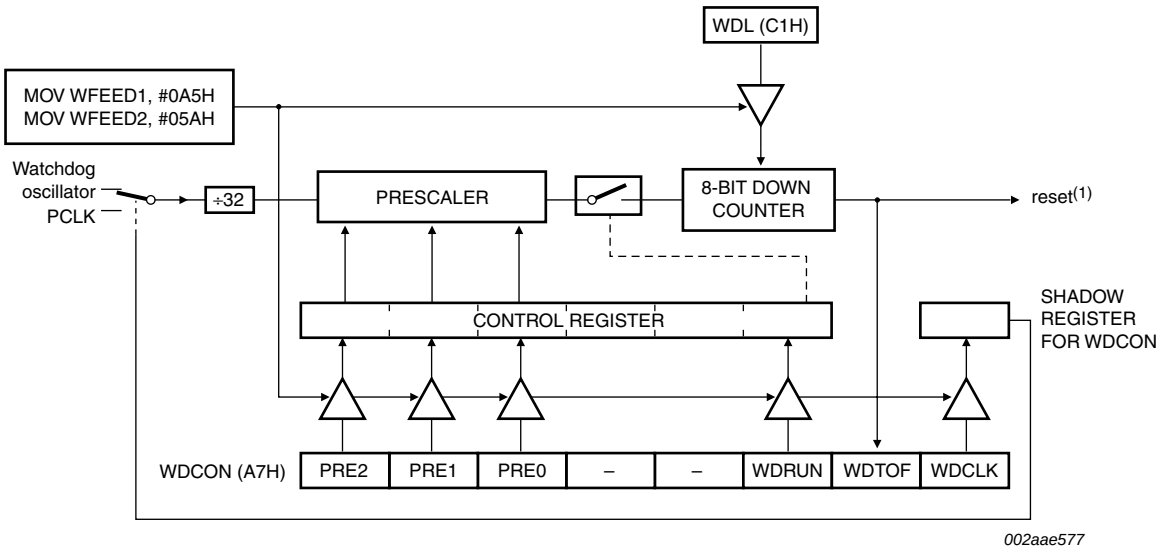
Each comparator has an interrupt flag contained in its configuration register. This flag is set whenever the comparator output changes state. The flag may be polled by software or may be used to generate an interrupt. The two comparators use one common interrupt vector. If both comparators enable interrupts, after entering the interrupt service routine, the user needs to read the flags to determine which comparator caused the interrupt.

7.24.3 Comparators and power reduction modes

Either or both comparators may remain enabled when Power-down or Idle mode is activated, but both comparators are disabled automatically in Total Power-down mode.

If a comparator interrupt is enabled (except in Total Power-down mode), a change of the comparator output state will generate an interrupt and wake-up the processor. If the comparator output to a pin is enabled, the pin should be configured in the push-pull mode in order to obtain fast switching times while in Power-down mode. The reason is that with the **oscillator** stopped, the temporary strong pull-up that normally occurs during switching on a quasi-bidirectional port pin does not take place.

Comparators consume power in Power-down and Idle modes, as well as in the normal operating mode. This fact should be taken into account when system power consumption is an issue. To minimize power consumption, the user can disable the comparators via PCONA.5, or put the device in Total Power-down mode.



(1) Watchdog reset can also be caused by an invalid feed sequence, or by writing to WDCON not immediately followed by a feed sequence.

Fig 20. Watchdog timer in Watchdog mode (WDTE = 1)

7.27 Additional features

7.27.1 Software reset

The SRST bit in AUXR1 gives software the opportunity to reset the processor completely, as if an external reset or watchdog reset had occurred. Care should be taken when writing to AUXR1 to avoid accidental software resets.

7.27.2 Dual data pointers

The dual Data Pointers (DPTR) provides two different Data Pointers to specify the address used with certain instructions. The DPS bit in the AUXR1 register selects one of the two Data Pointers. Bit 2 of AUXR1 is permanently wired as a logic 0 so that the DPS bit may be toggled (thereby switching Data Pointers) simply by incrementing the AUXR1 register, without the possibility of inadvertently altering other bits in the register.

7.28 Flash program memory

7.28.1 General description

The P89LPC9151/9161/9171 flash memory provides in-circuit electrical erasure and programming. The flash can be erased, read, and written as bytes. The Sector and Page Erase functions can erase any flash sector (256 bytes) or page (16 bytes). The Chip Erase operation will erase the entire program memory. ICP using standard commercial programmers is available. In addition, IAP (IAP-Lite) and byte-erase allows code memory to be used for non-volatile data storage. On-chip erase and write timing generation contribute to a user-friendly programming interface. The P89LPC9151/9161/9171 flash reliably stores memory contents even after 100,000 erase and program cycles. The cell is designed to optimize the erase and programming mechanisms. The

criteria, the boundary limits will again be compared after all 8 bits have been converted. The boundary status register (BNDSTA0) flags the channels which caused a boundary interrupt.

8.7 DAC output to a port pin with high output impedance

The DAC block of ADC1 can be output to a port pin. In this mode, the AD1DAT3 register is used to hold the value fed to the DAC. After a value has been written to the DAC (written to AD1DAT3), the DAC output will appear on the channel 3 pin.

8.8 Clock divider

The ADC requires that its internal clock source be in the range of 320 kHz to 8 MHz to maintain accuracy. A programmable clock divider that divides the clock from 1 to 8 is provided for this purpose.

8.9 Power-down and Idle mode

In Idle mode the A/C converter, if enabled, will continue to function and can cause the device to exit Idle mode when the conversion is completed if the A/D interrupt is enabled. In Power-down mode or Total Power-down mode, the A/D does not function. If the A/D is enabled, it will consume power. Power can be reduced by disabling the A/D.

9. Limiting values

Table 15. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).[1]

Symbol	Parameter	Conditions		Min	Max	Unit
$T_{amb(bias)}$	bias ambient temperature			−55	+125	°C
T_{stg}	storage temperature			−65	+150	°C
$I_{OH(I/O)}$	HIGH-level output current per input/output pin			-	20	mA
$I_{OL(I/O)}$	LOW-level output current per input/output pin			-	20	mA
$I_{I/Otot(max)}$	maximum total input/output current			-	100	mA
V_{xtal}	crystal voltage	on XTAL1, XTAL2; pin to V_{SS}		-	V_{DD} + 0.5	V
V_n	voltage on any other pin	except XTAL1, XTAL2; pin to V_{SS}		−0.5	+5.5	V
$P_{tot(pack)}$	total power dissipation (per package)	based on package heat transfer, not device power consumption		-	1.5	W
V_{ESD}	electrostatic discharge voltage	human body model; all pins	[2]	−3000	+3000	
		charged device model; all pins		−700	+700	

[1] The following applies to Table 15:

a) This product includes circuitry specifically designed for the protection of its internal devices from the damaging effects of excessive static charge. Nonetheless, it is suggested that conventional precautions be taken to avoid applying greater than the rated maximum.

b) Parameters are valid over ambient temperature range unless otherwise specified. All voltages are with respect to V_{SS} unless otherwise noted.

[2] Human body model: equivalent to discharging a 100 pF capacitor through a 1.5 kΩ series resistor.

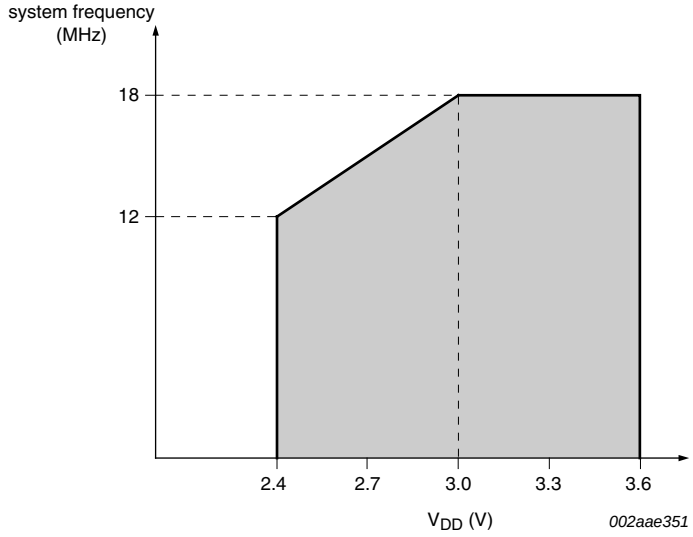


Fig 22. Frequency versus supply voltage

Table 16. Static characteristics *…continued*
V_{DD} = 2.4 V to 3.6 V unless otherwise specified.
T_{amb} = −40 °C to +85 °C for industrial applications, unless otherwise specified.

Symbol	Parameter	Conditions	Min	Typ[1]	Max	Unit
$R_{RST\_N(int)}$	internal pull-up resistance on pin $\overline{RST}$	pin $\overline{RST}$	10	-	30	kΩ
$V_{ref(bg)}$	band gap reference voltage		1.11	1.23	1.34	V
TC_{bg}	band gap temperature coefficient		-	10	20	ppm/°C

[1] Typical ratings are not guaranteed. The values listed are at room temperature, 3 V.

[2] The $I_{DD(oper)}$ specification is measured using an external clock with code while(1) {} executed from on-chip flash.

[3] The $I_{DD(idle)}$ specification is measured using an external clock with no active peripherals, with the following functions disabled: real-time clock and watchdog timer.

[4] The $I_{DD(pd)}$ specification is measured using internal RC oscillator with the following functions disabled: comparators, real-time clock, and watchdog timer.

[5] The $I_{DD(tpd)}$ specification is measured using an external clock with the following functions disabled: comparators, real-time clock, brownout detect, and watchdog timer.

[6] See Section 9 “Limiting values” for steady state (non-transient) limits on I_{OL} or I_{OH}. If I_{OL}/I_{OH} exceeds the test condition, V_{OL}/V_{OH} may exceed the related specification.

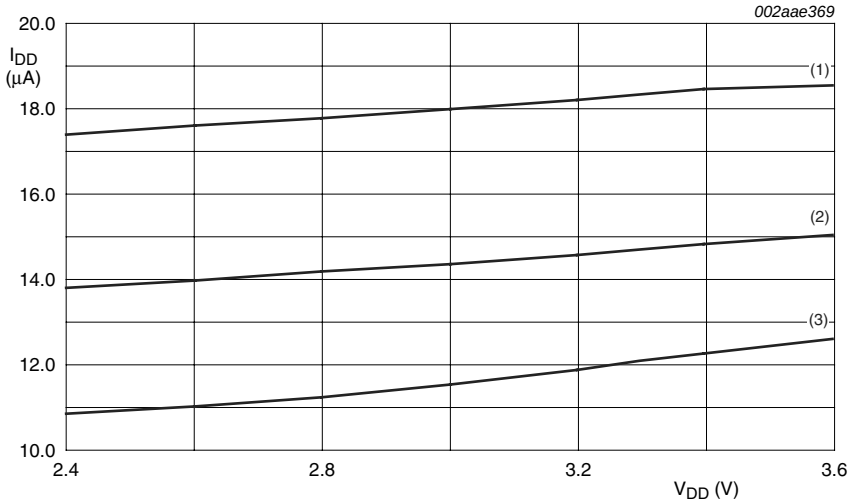
[7] This specification can be applied to pins which have A/D input or analog comparator input functions when the pin is not being used for those analog functions. When the pin is being used as an analog input pin, the maximum voltage on the pin must be limited to 4.0 V with respect to V_{SS}.

[8] Pin capacitance is characterized but not tested.

[9] Measured with port in quasi-bidirectional mode.

[10] Measured with port in high-impedance mode.

[11] Port pins source a transition current when used in quasi-bidirectional mode and externally driven from logic 1 to logic 0. This current is highest when V_I is approximately 2 V.



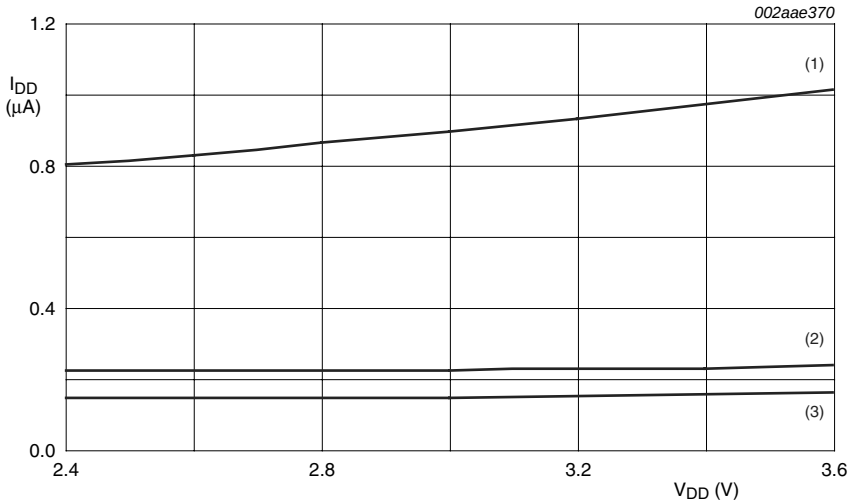
Test conditions: power-down mode, using internal RC oscillator with the following functions disabled: comparators, real-time clock, and watchdog timer.

(1) +85 °C

(2) +25 °C

(3) −40 °C

Fig 29. $I_{DD(pd)}$ versus V_{DD}



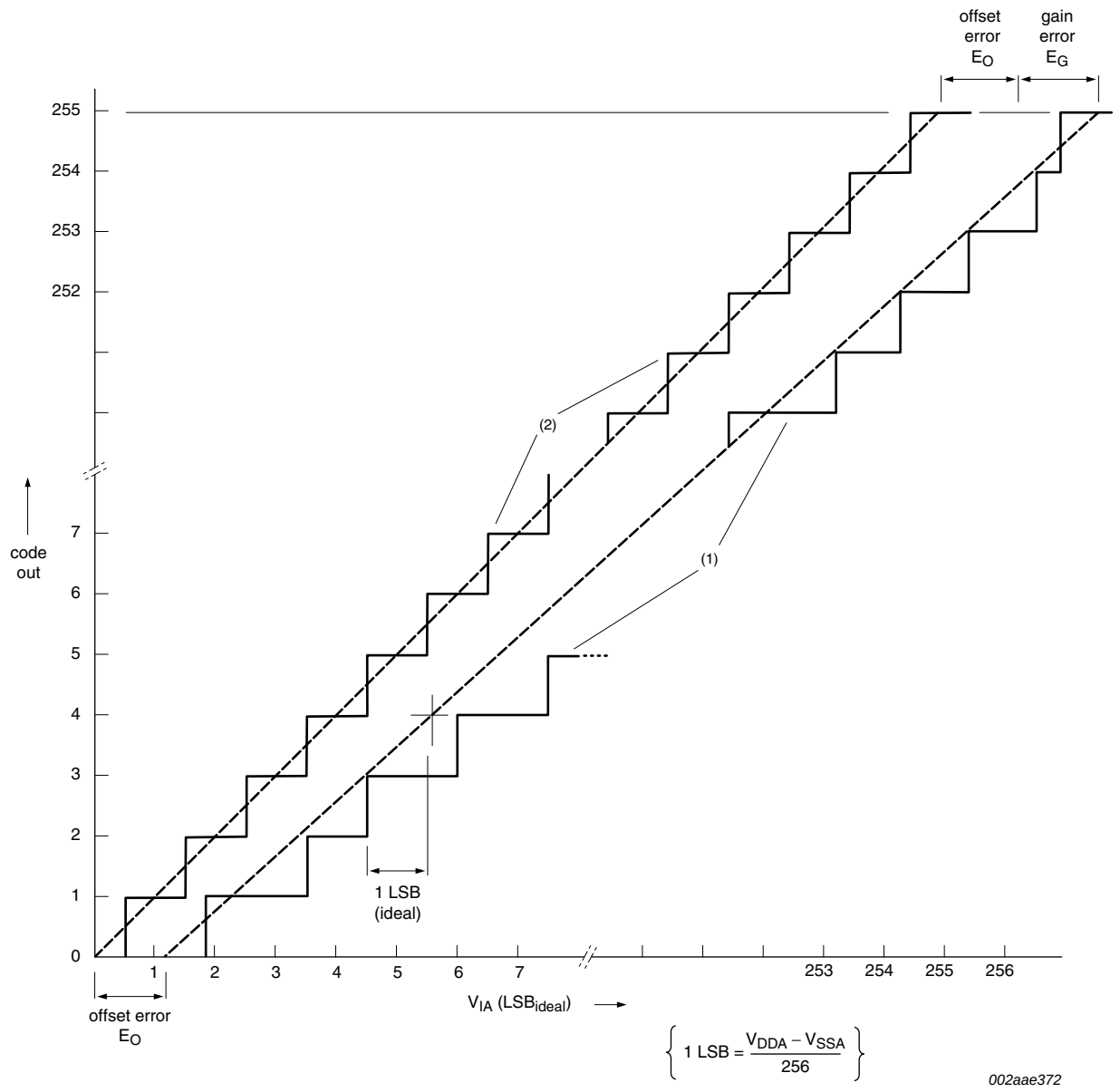
Test conditions: Total power-down mode, using internal RC oscillator with the following functions disabled: comparators, brownout detect, real-time clock, and watchdog timer.

(1) +85 °C

(2) −40 °C

(3) +25 °C

Fig 30. $I_{DD(tpd)}$ versus V_{DD}



(1) Example of an actual transfer curve.

(2) The ideal transfer curve.

Fig 45. ADC characteristics

15. Revision history

Table 23. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
P89LPC9151_61_71_2	20100209	Product data sheet	-	P89LPC9151_61_71_1
Modifications:	• Changed data sheet status to "Product data sheet".			
P89LPC9151_61_71_1	20091209	Preliminary data sheet	-	-

16. Legal information

16.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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